SOLID STATE OPTRONICS



AD6C331

1 Form A
250V / 10 Ω
MOSFET Output Solid State Relay

Description

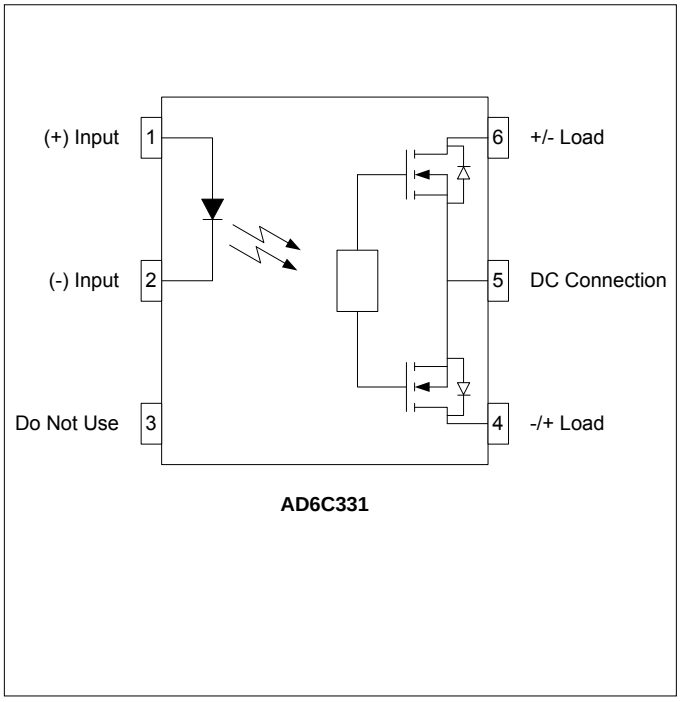
The AD6C331 is a bi-directional, single-pole, single-throw, normally open multipurpose solid-state relay in a compact 6 pin DIP package. It is designed to replace electromechanical relays in general purpose switching applications. The relay consists of an IR LED optically coupled to an IC that drives two rugged source-to-source enhancement type DMOS transistors. The device comes with up to 5kV input to output isolation.

The AD6C331 comes standard in a compact 6 pin DIP package making it ideal for high-density board applications.

Applications

- Reed Relay Replacement
- Security Systems
- Meter Reading Equipment
- Data Acquisition
- Battery Monitoring
- Multiplexers

Schematic Diagram



AD6C331

Features

- Compact 6 pin DIP/SMD Package
- High Input-to-Output Isolation (up to $5V_{RMS}$)
- Low Input Control Current (2.5mA TYP)
- 200mA Maximum Continuous Load Current
- Low On Resistance (6Ω TYP)
- Long Life / High Reliability
- RoHS / Pb-Free / REACH Compliant

Agency Approvals

UL/C-UL:	File # E201932
VDE:	File # 40035191 (EN 60747-5-2)

Absolute Maximum Ratings

The values indicated are absolute stress ratings. Functional operation of the device is not implied at these or any conditions in excess of those defined in electrical characteristics section of this document. Exposure to absolute Maximum Ratings may cause permanent damage to the device and may adversely affect reliability.

Storage Temperature	-55 to +125°C
Operating Temperature	-40 to +85°C
Continuous Input Current	50mA
Transient Input Current	500mA
Reverse Input Control Voltage	5V
Input Power Dissipation	40mW
Output Power Dissipation	800mW
Solder Temperature – Wave (10sec)	260°C
Solder Temperature – IR Reflow (10sec)	260°C

Ordering Information

Part Number	Description
AD6C331	6 pin DIP, (50/Tube)
AD6C331-H	$5kV_{RMS}$ V_{ISO}, 6 pin DIP, (50/Tube)
AD6C331-S	6 pin SMD, (50/Tube)
AD6C331-HS	$5kV_{RMS}$, 6 pin SMD, (50/Tube)
AD6C331-STR	6 pin SMD, Tape and Reel (1000/Reel)
AD6C331-HSTR	$5kV_{RMS}$, 6 pin SMD, Tape and Reel (1000/Reel)

NOTE: Suffixes listed above are not included in marking on device for part number identification

© 2013 Solid State Optronics • San José, CA
www.ssousa.com • +1.408.293.4600

AD6C331 H/S/TR
Rev 2.00 (11/25/2013)
001742

Electrical Characteristics, T_A = 25°C (unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Input Specifications						
LED Forward Voltage	V_F	-	1.2	1.5	V	I_F = 10mA
LED Reverse Voltage	BV_R	5	-	-	V	I_R = 10µA
Input Reverse Current	I_R	-	-	10	µA	V_R = 5V
Turn-On Current	I_F	-	2.5	5	mA	I_O = 200mA (within 10mS)
Turn-Off Current	$I_{F(OFF)}$	-	0.5	-	mA	I_O = 200mA
Output Specifications						
Blocking Voltage	V_B	250	-	-	V	I_O=1µA
Continuous Load Current	I_O	-	-	200	mA	I_F=5mA
On Resistance	R_{ON}	-	6	10	Ω	I_F=5mA, I_O=200mA
Leakage Current	I_{Oleak}	-	0.2	1	µA	I_F=0mA, V_O=250V
Output Capacitance	C_{OUT}	-	25	-	pF	V_O=25V, f=1.0MHz
Offset Voltage	V_{OFFSET}	-	-	0.2	mV	I_F=5mA
Coupled Specifications						
Turn-On Time	T_{ON}	-	2	5	mS	I_F=5mA, I_O=200mA
Turn-Off Time	T_{OFF}	-	0.15	0.5	mS	I_F=0mA, I_O=200mA
Coupled Capacitance	$C_{COUPLED}$	-	3	-	pF	
Contact Transient Ratio	-	2,000	7,000	0	V/µS	dV = 50V
Isolation Specifications						
Isolation Voltage	V_{ISO}	3750	-	-	V_{RMS}	RH ≤ 50%, t=1min
(-H Option)		5000	-	-		
Input-Output Resistance	R_{I-O}	-	10^{12}	-	Ω	V_{I-O} = 500V_{DC}

© 2013 Solid State Optronics • San José, CA

AD6C331 Performance & Characteristics Plots, T_A = 25°C (unless otherwise specified)

Figure 1: *Typical Turn-On Time Distribution* (N = 100, T_a = 25ºC)

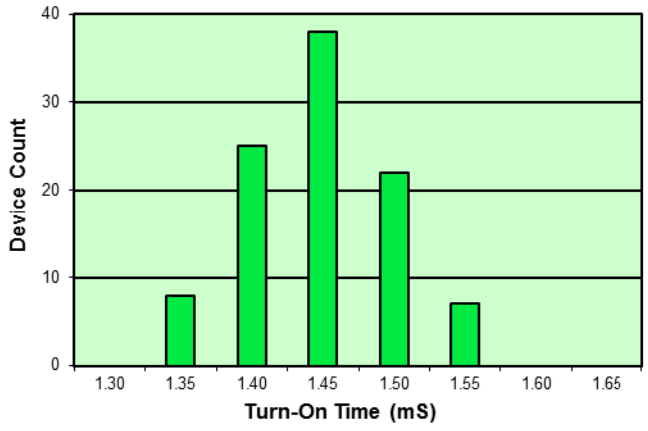


Figure 2: *Typical Turn-Off Time Distribution* (N = 100, T_a = 25ºC)

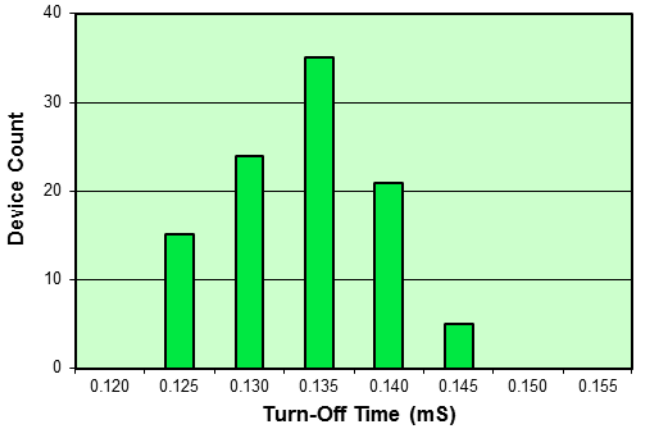


Figure 3: *Typical On-Resistance Distribution* (N = 100, T_a = 25ºC)

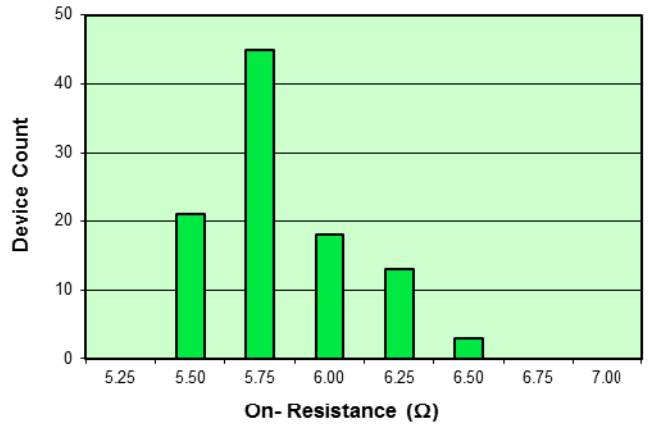


Figure 4: *Typical Output Leakage Current Distribution* (N = 100, T_a = 25ºC)

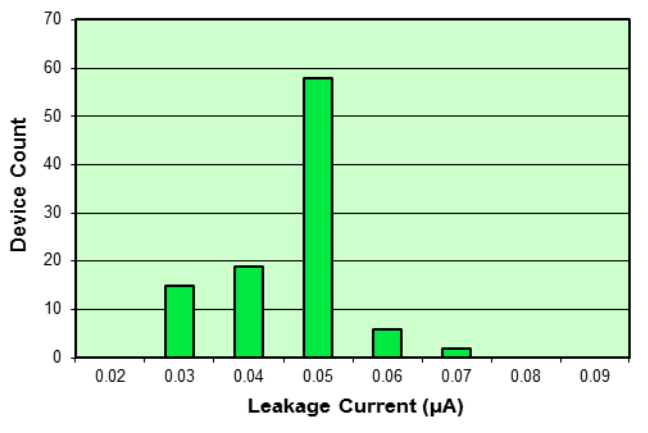


Figure 5: *Typical Blocking Voltage Distribution* (N = 100, Ta = 25ºC)

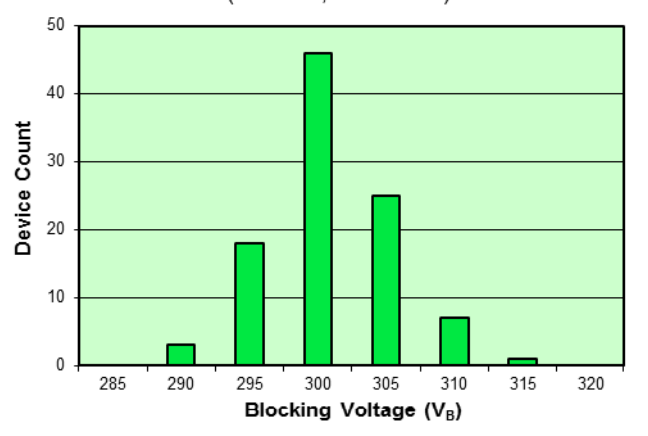
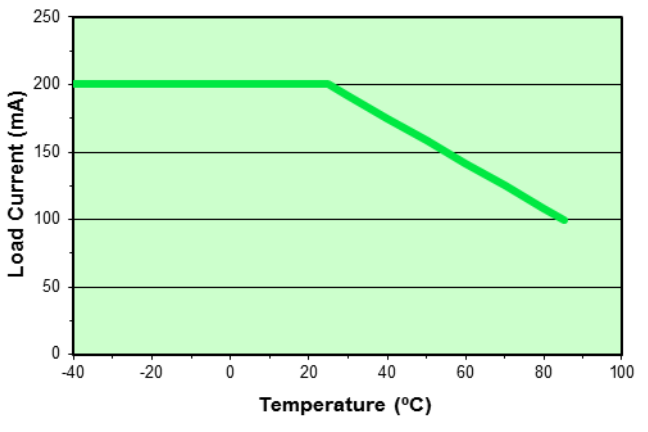


Figure 6: *Maximum Load Current vs. Temperature*



© 2013 Solid State Optronics • San José, CA

AD6C331 Solder Temperature Profile Recommendations

(1) *Infrared Reflow:*

Refer to the following figure as an example of an optimal temperature profile for single occurrence infrared reflow. Soldering process should not exceed temperature or time limits expressed herein. Surface temperature of device package should not exceed 250ºC:

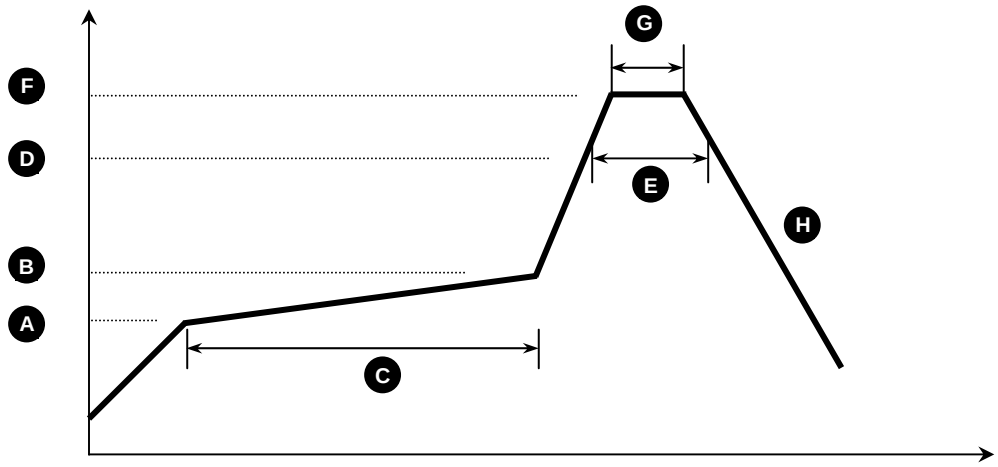


Figure 1

Process Step	Description	Parameter
A	Preheat Start Temperature (ºC)	150ºC
B	Preheat Finish Temperature (ºC)	180ºC
C	Preheat Time (s)	90 - 120s
D	Melting Temperature (ºC)	230ºC
E	Time above Melting Temperature (s)	30s
F	Peak Temperature, at Terminal (ºC)	260ºC
G	Dwell Time at Peak Temperature (s)	10s
H	Cool-down (ºC/s)	<6ºC/s

(2) *Wave Solder:*

Maximum Temperature:	260ºC (at terminal)
Maximum Time:	10s
Pre-heating:	100 - 150ºC (30 - 90s)
Single Occurrence	

(3) *Hand Solder:*

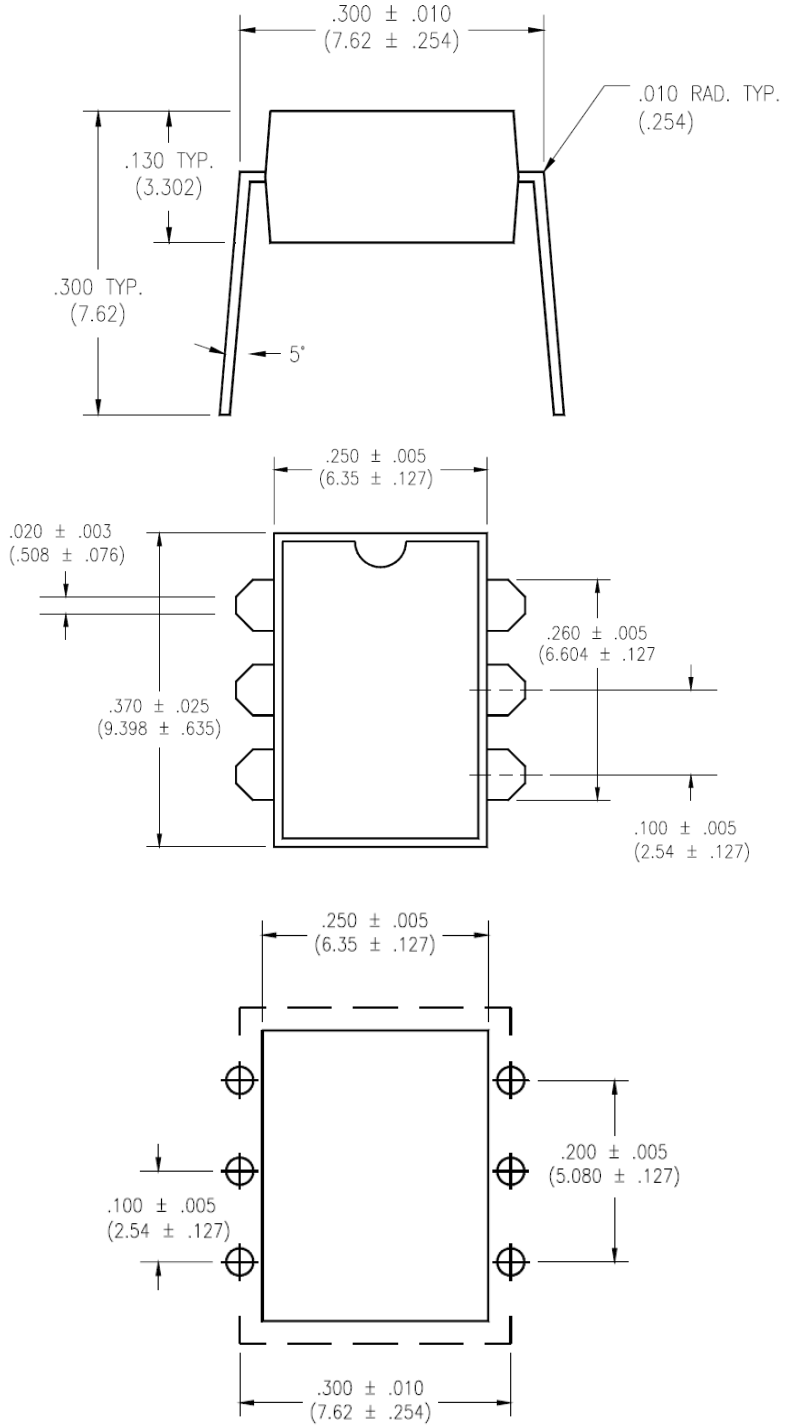
Maximum Temperature:	350ºC (at tip of soldering iron)
Maximum Time:	3s
Single Occurrence	

© 2013 Solid State Optronics • San José, CA

AD6C331 Package Dimensions

6 PIN DIP Package

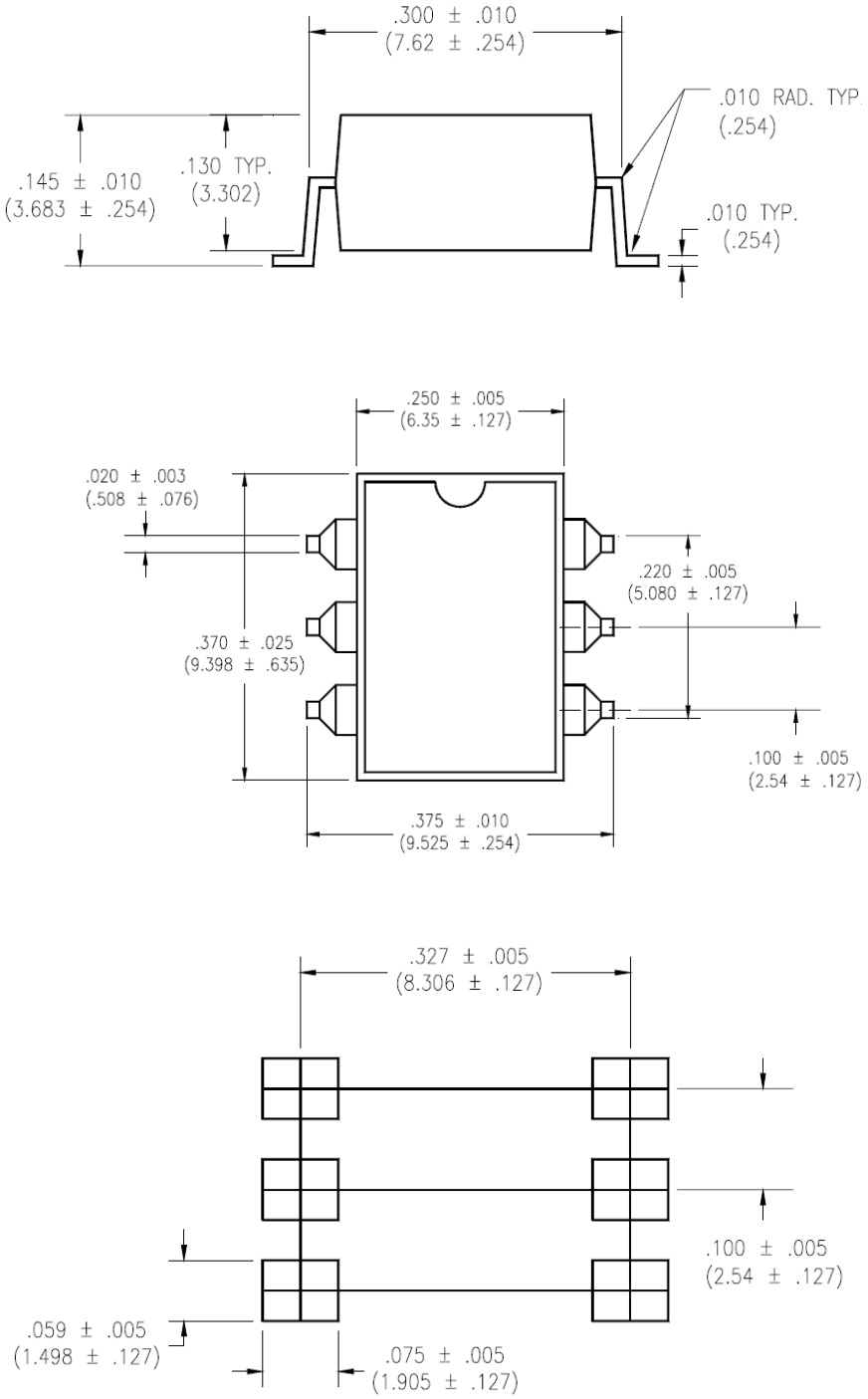
Note: *All dimensions in inches ["] with millimeters in parenthesis ()*



AD6C331 Package Dimensions

6 PIN SMD Surface Mount Package (-S)

Note: *All dimensions in inches ["] with millimeters in parenthesis ()*

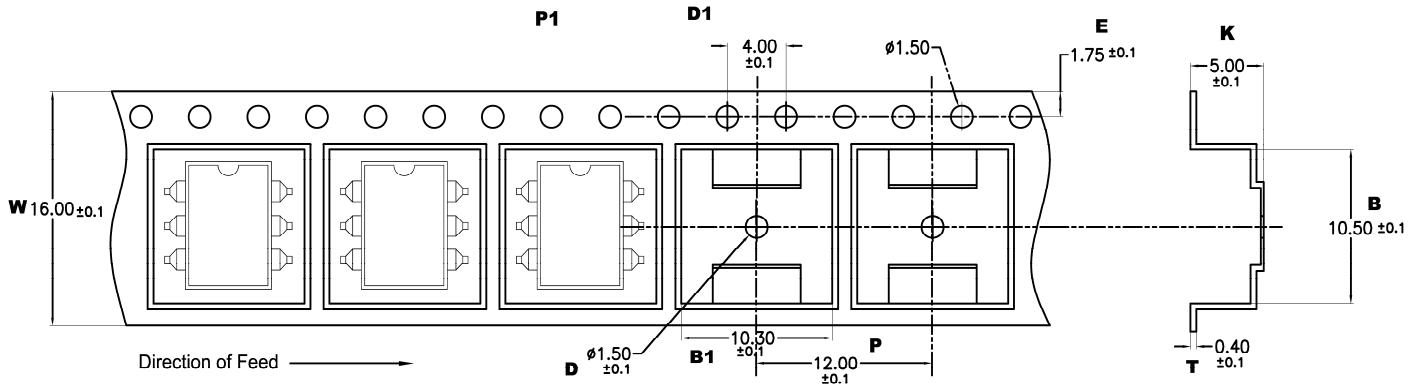


AD6C331 Package Dimensions

6 PIN SMD Tape & Reel (-STR)

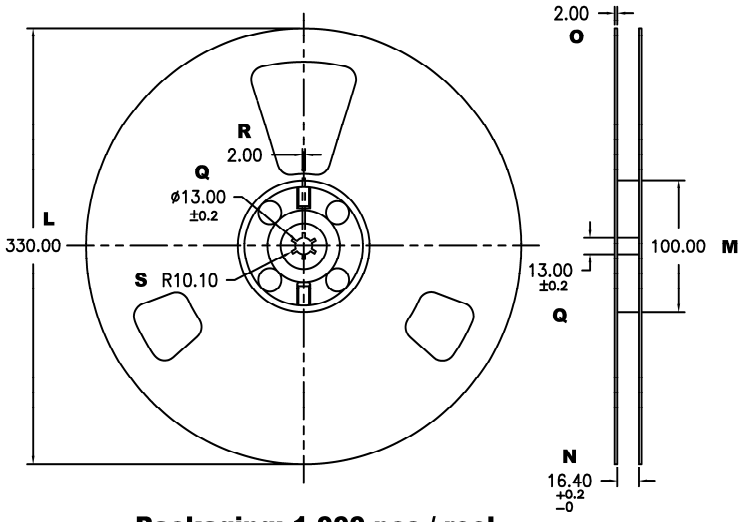
Note: *All dimensions in millimeters*

Outline and Dimension (Tape)



W	B	B1	P	P1	K	E	T	D	D1
16.00 ±0.1	10.50 ±0.1	10.30 ±0.1	12.00 ±0.1	4.00 ±0.1	5.00 ±0.1	1.75 ±0.1	0.40 ±0.1	1.50 ±0.1	1.50 ±0.1

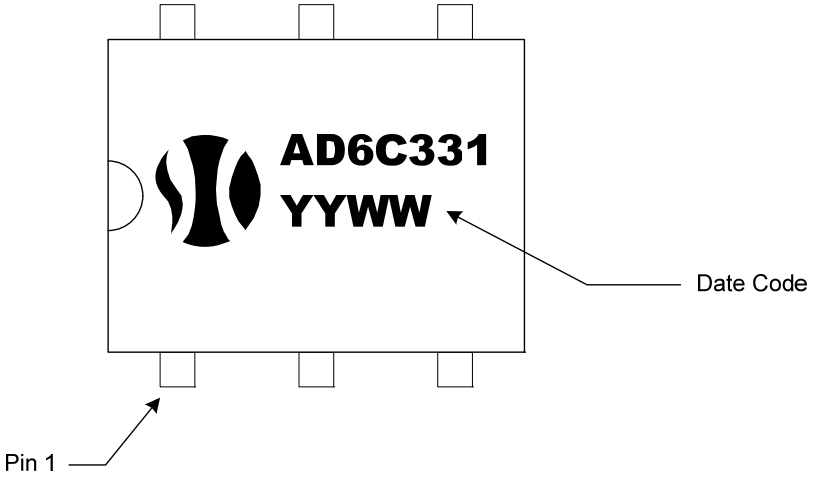
Outline and Dimensions (Reel)



Packaging: 1,000 pcs / reel

L	M	N	O	Q	R	S
330.00	100.00	16.40 +0.2	2.00 ±0.1	13.00 ±0.2	2.00	10.00

AD6C331 Package Marking



AD6C331 Package Weights

Device	Single Unit	Full Tube (50pcs)	Full Pouch (10 tubes)	Full Reel (1000pcs)
AD6C331-(H)	0.45	48	490	-
AD6C331-(H)S	0.44	46	470	-
AD6C331-(H)STR	0.44	-	-	884

Note: *All weights above are in GRAMS, and include packaging materials where applicable*

DISCLAIMER

Solid State Optronics (SSO) makes no warranties or representations with regards to the completeness and accuracy of this document. SSO reserves the right to make changes to product description, specifications at any time without further notices.
SSO shall not assume any liability arising out of the application or use of any product or circuit described herein. Neither circuit patent licenses nor indemnity are expressed or implied.
Except as specified in SSO's Standard Terms & Conditions, SSO disclaims liability for consequential or other damage, and we make no other warranty, expressed or implied, including merchantability and fitness for particular use.

LIFE SUPPORT POLICY

SSO does not authorize use of its devices in life support applications wherein failure or malfunction of a device may lead to personal injury or death. Users of SSO devices in life support applications assume all risks of such use and agree to indemnify SSO against any and all damages resulting from such use. Life support devices are defined as devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when used properly in accordance with instructions for use can be reasonably expected to result in significant injury to the user, or (d) a critical component of a life support device or system whose failure can be reasonably expected to cause failure of the life support device or system, or to affect its safety or effectiveness.

© 2013 Solid State Optronics • San José, CA